

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Yin et al.

Serial No.: 09/293,188

Filed: April 16, 1999

For: METHOD OF FORMING
INTERCONNECT STRUCTURE WITH
INTERLAYER DIELECTRIC (as amended)

Confirmation No.: 4546

Examiner: P. Cao

Group Art Unit: 2814

Attorney Docket No.: 2269-6910.1US
(97-1121.01/US)

Notice of Allowance Mailed:

May 24, 2007

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AUGUST 10, 2007

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES
RELATING TO MAINTENANCE FEES**

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

MICRON TECHNOLOGY, INC.
Mail Stop 525
8000 South Federal Way
Boise, Idaho 83707-0006

Serial No.: 09/293,188

2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



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Date: August 10, 2007

KWP/ps:lmh

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